

### 1. Features

- Typical 1dB bandwidth of 30.4 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

**RoHS Compliant**

Tested by SGS Testing Korea

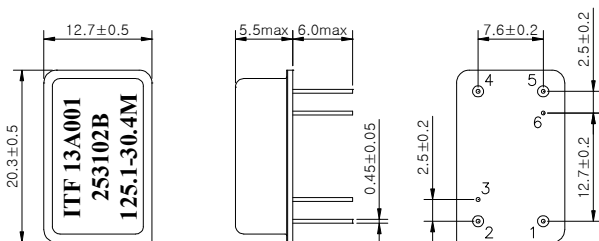
### 2. Electrical Specifications

Source and Load Impedance = 50Ω

Operating Temperature : -30°C ~ +85°C		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	-	125.1	-
Insertion Loss	dB	-	23.2	24.5
1dB Bandwidth	MHz	30.3	30.46	-
3dB Bandwidth	MHz	-	31.0	-
40dB Bandwidth	MHz	-	33.2	33.35
Amplitude Ripple (Fo±14.22 MHz)	dB	-	0.45	1.0
Group Delay Variation (Fo±14.22 MHz)	nsec	-	20	50
Absolute Delay	usec	-	1.29	-
Ultimate Rejection	dB	48	52	-
Maximum input Power	dBm	-	-	10
Temperature Coefficient of Frequency	ppm/°C	-	-72	-

Room Temperature : +25°C		Minimum	Typical	Maximum
Insertion Loss	dB	-	23.2	24.5
Amplitude Ripple (Fo±14.72 MHz)	dB	-	0.45	1.0
Group Delay Variation (Fo±14.72 MHz)	nsec	-	20	50

#### D2012 Package Dimension



#### Matching Schematic



**L1 = 56nH, L2 = 68nH**

Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated  
 Cap : Cu & Cr Alloy, Ni Plated  
 Termination : Kovar, Au Plated

#### Pin Configuration

	1	Ground	2,4
Input	1	Ground	2,4
Output	5	Others	Ground

### 3. Typical Performance ( at +25°C )

